

STW60NM50N

N-channel 500 V, 0.035 Ω, 68 A, MDmesh™ II Power MOSFET in a TO-247 package

Datasheet - production data

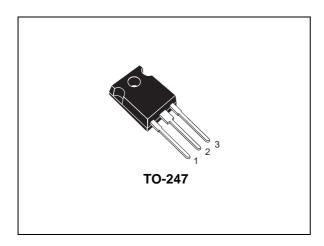
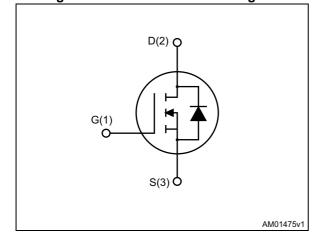


Figure 1. Internal schematic diagram



Features

Order code	V _{DSS} (@T _{jmax})	R _{DS(on) max}	I _D
STW60NM50N	550 V	<0.043 Ω	68 A

- 100% avalanche tested
- Low input capacitance and gate charge
- · Low gate input resistance

Applications

· Switching applications

Description

This device is an N-channel Power MOSFET developed using the second generation of MDmesh™ technology. This revolutionary Power MOSFET associates a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

Table 1. Device summary

Order codes	Marking	Packages	Packaging
STW60NM50N	60NM50N	TO-247	Tube

Contents STW60NM50N

Contents

1	Electrical ratings	. 3
2	Electrical characteristics	. 4
	2.1 Electrical characteristics (curves)	. 6
3	Test circuits	. 8
4	Package mechanical data	. 9
5	Revision history	12

STW60NM50N Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate- source voltage	±25	V
I _D	Drain current (continuous) at T _C = 25 °C	68	Α
I _D	Drain current (continuous) at T _C = 100 °C	43	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	272	Α
P _{TOT}	Total dissipation at T _C = 25 °C	446	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
T _{stg}	Storage temperature	-55 to 150	°C
T _j	Max. operating junction temperature	150	°C

^{1.} Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.28	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	50	°C/W

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AS}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_{jMax})	11	А
E _{AS}	Single pulse avalanche energy (starting Tj=25 °C, I _D =I _{AS} , V _{DD} =50 V)	551	mJ

^{2.} $I_{SD} \leq$ 68 A, di/dt \leq 400 A/ μ s, V_{DD} =80% $V_{(BR)DSS}$

Electrical characteristics STW60NM50N

2 Electrical characteristics

(T_{CASE}=25 °C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0$, $I_D = 1$ mA	500			V
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0$, $V_{DS} = 500 \text{ V}$ $V_{GS} = 0$, $V_{DS} = 500 \text{ V}$, $T_j = 125 \text{ °C}$			1 100	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0, V_{GS} = \pm 20 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 34 A		0.035	0.043	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	5790	-	pF
C _{oss}	Output capacitance	$V_{DS} = 100 \text{ V, f} = 1 \text{ MHz,}$	-	365	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	14	-	pF
C _{oss eq.} (1)	Equivalent output capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{V to } 480 \text{ V}$	-	1008	-	pF
Qg	Total gate charge	V _{DD} = 480 V, I _D = 68 A, V _{GS} = 10 V	-	178	-	nC
Q_{gs}	Gate-source charge		-	28	-	nC
Q _{gd}	Gate-drain charge	(see Figure 14)		95	-	nC
R _g	Gate input resistance	f=1 MHz gate DC bias=0 Test signal level = 20 mV open drain	-	2	-	Ω

^{1.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS}

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	206	-	ns
t _r	Rise time	$V_{DD} = 300 \text{ V}, I_{D} = 32.5 \text{ A}$ $R_{G} = 4.7 \Omega V_{GS} = 10 \text{ V}$	-	36	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 13)	-	40	-	ns
t _f	Fall time		-	27.5	-	ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				68	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		272	Α
V _{SD} (2)	Forward on voltage	I _{SD} = 68 A, V _{GS} = 0	-		1.6	٧
t _{rr}	Reverse recovery time	I _{SD} = 68 A, di/dt = 100 A/μs	ı	476		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 100 V	ı	10.5		nC
I _{RRM}	Reverse recovery current	(see Figure 15)	ı	44		Α
t _{rr}	Reverse recovery time	I _{SD} = 68 A, di/dt = 100 A/μs	ı	586		ns
Q _{rr}	Reverse recovery charge	$V_{DD} = 100 \text{ V}, T_j = 150 ^{\circ}\text{C}$	-	15		nC
I _{RRM}	Reverse recovery current	(see Figure 15)	-	51		Α

^{1.} Pulse width limited by safe operating area.



^{2.} Pulsed: Pulse duration = 300 μs, duty cycle 1.5%

Electrical characteristics STW60NM50N

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

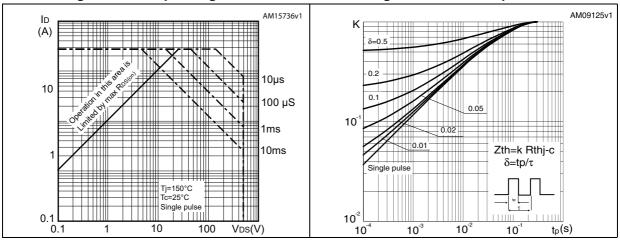


Figure 4. Output characteristics

Figure 5. Transfer characteristics

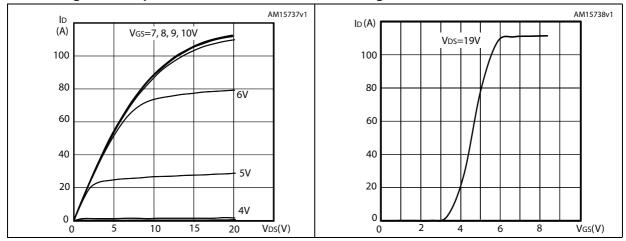
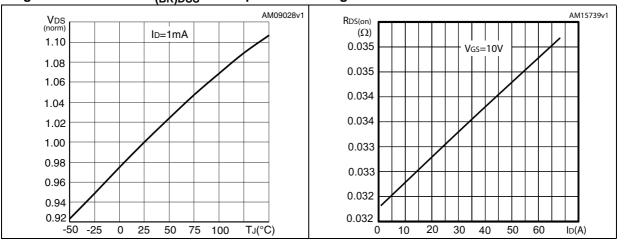


Figure 6. Normalized $V_{(BR)DSS}$ vs temperature

Figure 7. Static drain-source on-resistance



6/13 DocID023157 Rev 2

Figure 8. Gate charge vs gate-source voltage

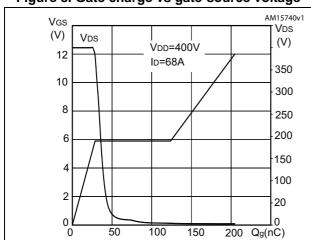


Figure 9. Capacitance variations

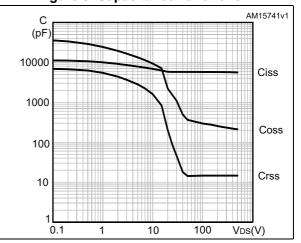
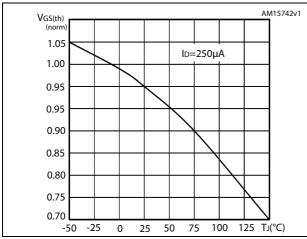


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on-resistance vs temperature



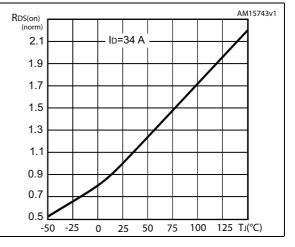
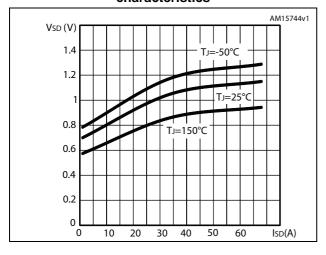


Figure 12. Source-drain diode forward characteristics



Test circuits STW60NM50N

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

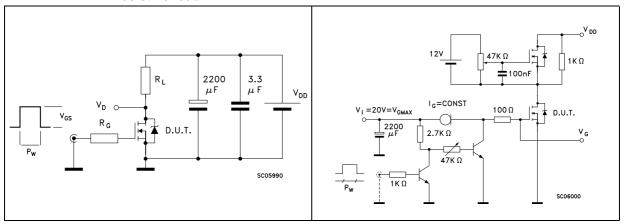


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

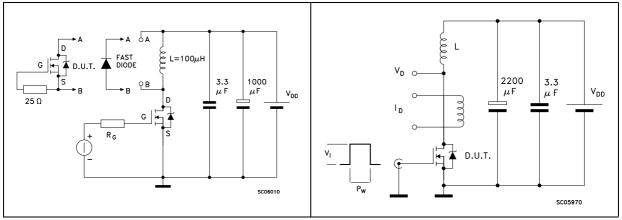
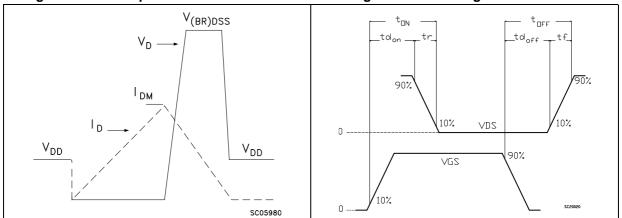


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



8/13 DocID023157 Rev 2

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



DocID023157 Rev 2

Table 9. TO-247 mechanical data

Dim.		mm.			
Dilli.	Min.	Тур.	Max.		
А	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0	3.40			
С	0.40	0.80			
D	19.85	20.15			
E	15.45	15.7			
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		

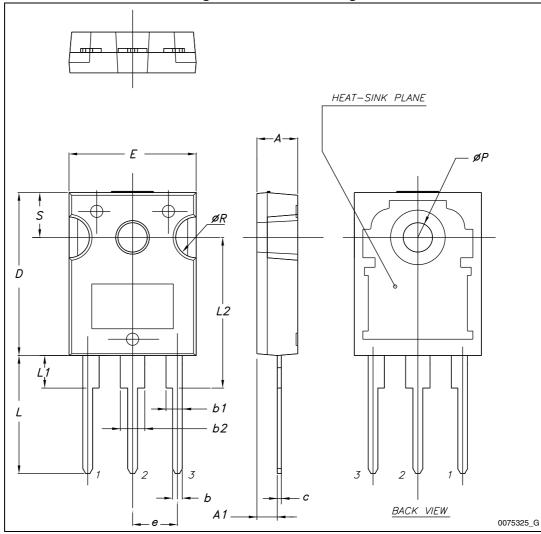


Figure 19. TO-247 drawing

Revision history STW60NM50N

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
26-Apr-2012	1	First release.
16-Apr-2013	2	 Inserted: Section 2.1: Electrical characteristics (curves) Modified: I_{AS} value on Table 4 Minor text changes

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT AUTHORIZED FOR USE IN WEAPONS. NOR ARE ST PRODUCTS DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



DocID023157 Rev 2

13/13